RABIN & CHAMPAGNE, P.C.

06 - 30 - 1998

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STEVEN M. RABIN THOMAS M. CHAMPAGNE* ROBERT H. BERDO, JR.

ADMITTED TO A BAR OTHER THAN D.C.

SUITE 1111 1725 K STREET, N.W HINGTON, D.C. 20006 JUN 1 5 **1998**

PATENT, TRADEMARK AND COPYRIGHT LAW TELEPHONE: (202) 659-1915 TELEFAX: (202) 659-1898 E-MAIL: rabinlaw@aol.com

VER SHEET - PATENT APPLICATION RECOR

NAME OF CONVEYING PARTY Jason JENQ

NAME OF RECEIVING PARTY **United Microelectronics Corporation**

ADDRESS OF RECEIVING PARTY No. 3, Li-hsin Rd. II. Science-Based

Industrial Park Hsin-Chu, Taiwan, R.O.C.

6.15.98

NATURE OF CONVEYANCE Assignment of U.S. patent application

CONVEYANCE EXECUTION DATE December 12, 1997

PATENT APPLICATION NO. 09/009.508

APPLICATION FILED TOGETHER WITH THIS DOCUMENT NO

APPLICATION EXECUTION DATE

December 12, 1997 CORRESPONDENCE

ADDRESS RABIN & CHAMPAGNE, P.C.

1725 K Street, N.W., Suite 1111

Washington, D.C. 20006

ATTORNEY REFERENCE JIA 545

TOTAL NUMBER OF PATENTS

AND APPLICATIONS INVOLVED One **TOTAL FEE PAID** \$40.00

METHOD OF PAYMENT [X] Enclosed

Authorized to be charged to

deposit account

In the event there is attached hereto no check, or a check for an insufficient amount, please charge the fee to our Account No. 18-0002 and notify us accordingly.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Steven M. Rabin

06/26/1998 TSTOKES 00000039 090095(RegistNation No. 29,102)

SMR/dmb 03 FC:581 40.00 DD Total number of pages including cover sheet, attachments and document: 3

PATENT

REEL: 9263 FRAME: 0043

ASSIGNMENT

WHEREAS, (1) Jason Jenq

(2)Sun-Chieh Chien

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD OF FABRICATING A CAPACITOR OF A DYNAMIC RANDOM ACCESS MEMORY

[] Filed

Serial No

[x] Executed concurrently with the execution of this instrument

WHEREAS, United Microelectronics Corp., of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor. Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

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ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF. Assignor has/have signed his/her/their name(s) on the date(s)

Signature date

Signature date

date

Signature

RECORDED: 06/15/1998